



SOT426

plastic single-ended surface-mounted package (D2PAK); 5 leads (one lead cropped)

8 February 2016

Package information

1. Package summary

Terminal position code	S (single)
Package type descriptive code	D2PAK
Package type industry code	D2PAK
Package style descriptive code	SMS (surface-mounted single in-line)
Package style suffix code	NA (not applicable)
Package body material type	P (plastic)
Mounting method type	S (surface mount)
Issue date	16-3-2006

Table 1. Package summary

Symbol	Parameter	Min	Typ	Nom	Max	Unit
D	package length	[tbd]	-	11	11	mm
E	package width	9.7	-	10	10.3	mm
A	seated height	4.1	-	4.3	4.5	mm
e	nominal pitch	-	-	1.7	-	mm
n ₂	actual quantity of termination	-	-	5	-	



2. Package outline

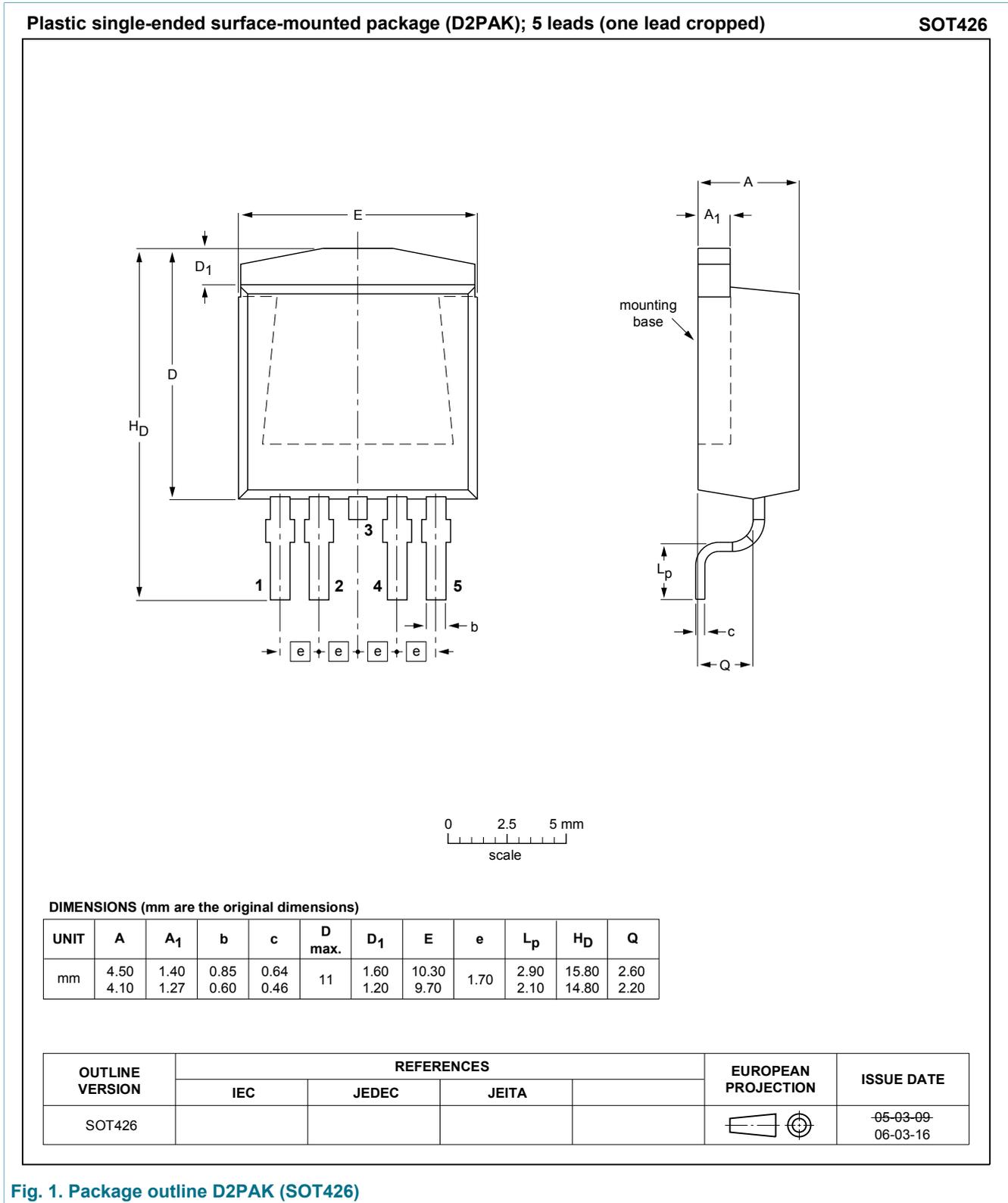
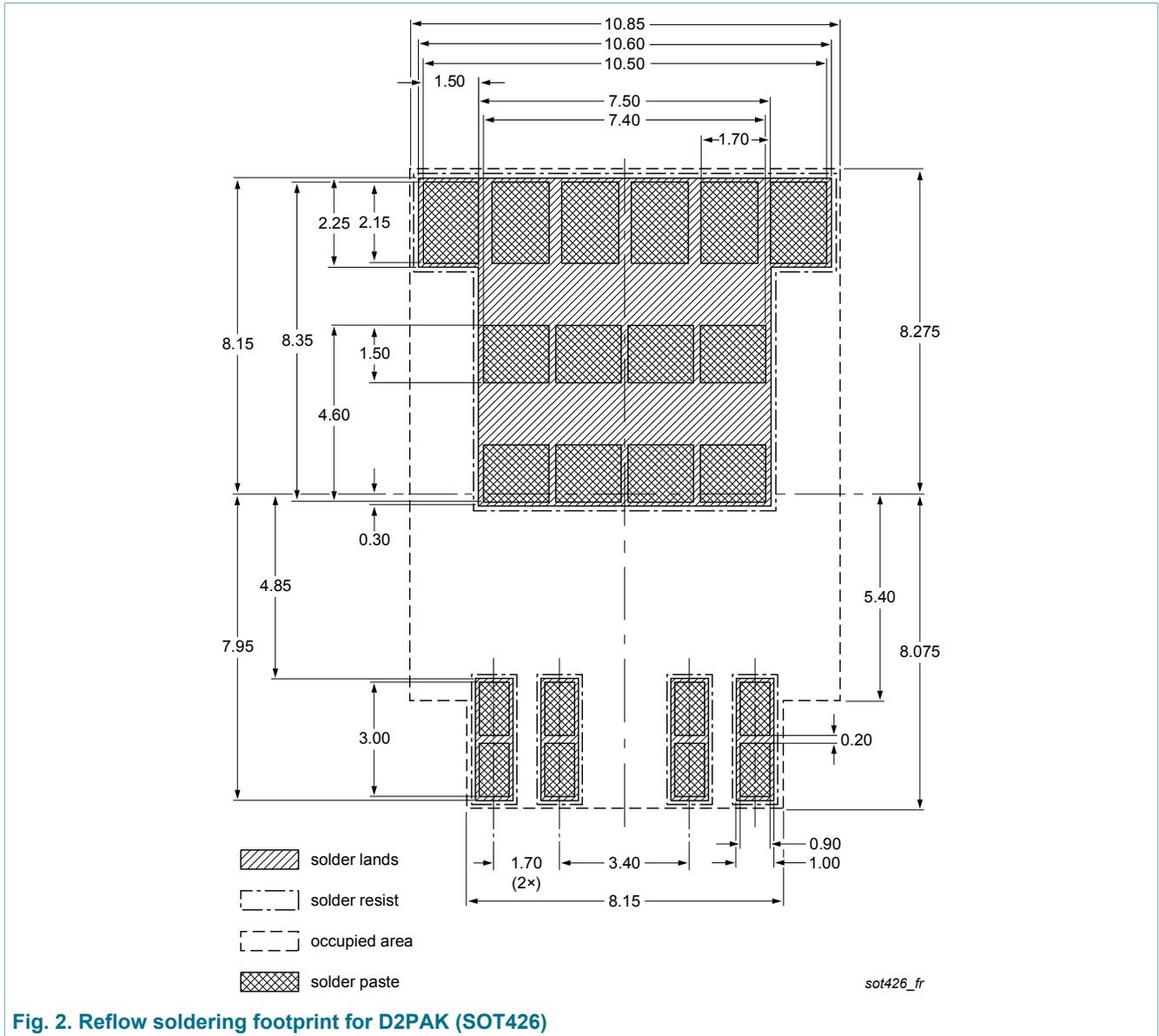


Fig. 1. Package outline D2PAK (SOT426)

3. Soldering



4. Legal information

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